



PATENT  
Docket No.: 19226/2331 (R-5839)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant	:	Deborah D.L. Chung	)	Examiner:
			)	C. Lam
Serial No.	:	10/807,487	)	
Cnfrm. No.	:	3059	)	Art Unit:
			)	1775
Filed	:	March 23, 2004	)	
For	:	THERMAL PASTE FOR IMPROVING	)	
		THERMAL CONTACTS	)	

AMENDMENT

**Mail Stop Amendment**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the April 11, 2005, office action, please amend the above-identified patent application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks** begin on page 17 of this paper.

10/17/2005 BABRAHA1 00000058 10807487

02 FC:2202	300.00 OP
03 FC:2201	100.00 OP